

Amendments to the Specification:

Please amend the title as follows:

~~STACKED MICROELECTRONIC DIES AND METHODS FOR STACKING
MICROELECTRONIC DIES~~

Please amend the CROSS REFERENCE TO RELATED APPLICATION section on page one as follows:

This application is a divisional application of United States Patent Application No. 09/644,766 entitled "STACKED MICROELECTRONIC DIES AND METHODS FOR STACKING MICROELECTRONIC DIES," filed on August 23, 2000, now Patent No. 6,607,937, issued August 19, 2003, which is incorporated herein by reference in its entirety.